

Attorney Docket No.: 0400204D

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: **Kinzer et al.**

Art Unit: 2811

Serial No.: 10/613,326

Examiner: Nadav, Ori

Filing Date: 07/03/2003

For: **Vertical Conduction Flip-Chip
Device with Bump Contacts on
Single Surface**

RESPONSE TO NON-FINAL OFFICE ACTION

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir/Madam:

This is in response to the Non-Final Office Action dated August 25, 2010 in the above-referenced patent application. Please enter and consider the following remarks.

The Commissioner is hereby authorized to charge payment of any additional fees associated with this communication, or credit any overpayment to Deposit Account No.

50-0731.

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